

。 产品简述

RHF0M084是瑞兴恒方网络(深圳)有限公司设计的低成本, 超低功耗, 超小尺寸的LoRaWAN® 模组, 模块采用 ST 系统级芯片 STM32WLE5JC, 内部集成高性能 LoRa® SX126X IP 和超低功耗 MCU ,还搭载Semtech专有的2.4G长距离收发器SX1281。 该模块的目标应用是无线传感网络和其他物联网设备, 尤其是有电池供电要求低功耗和远距离的场合。

外观



应用领域

- LoRaWAN®节点
- 家庭自动化应用
- 智能安全
- 低功耗无线传感器网络
- 2.4GHz远程应用

功能和特点

- 低功耗: 低至2uA 睡眠电流 (WOR 模式)
- 小尺寸: 28mm X 23mm X 2.8mm 33 pins SMT
- 高性能:
 - 高发射功率:
 - TXOP=22dBm@470MHz
 - TXOP=22dBm@868/915MHz

- TXOP=13dBm@2400MHz

高接收灵敏度:

- 470MHz:-134 dBm sensitivity for SF12 with 125KHz BW
- 868MHz:-132 dBm sensitivity for SF12 with 125KHz BW
- 2400MHz:-130 dBm sensitivity for SF12 with 125KHz BW
- 灵活的接口
 - SPI
 - USART
 - I2C
 - ADC
 - GPIO
 - SWD
- 内嵌LoRaWAN® 协议, AT指令, 支持全球LoRaWAN®频率计划
 - EU868
 - US915 and US915 Hybrid
 - CN779
 - AU915
 - CN470 and CN470 Prequet
 - AS923
 - KR920
 - IN865

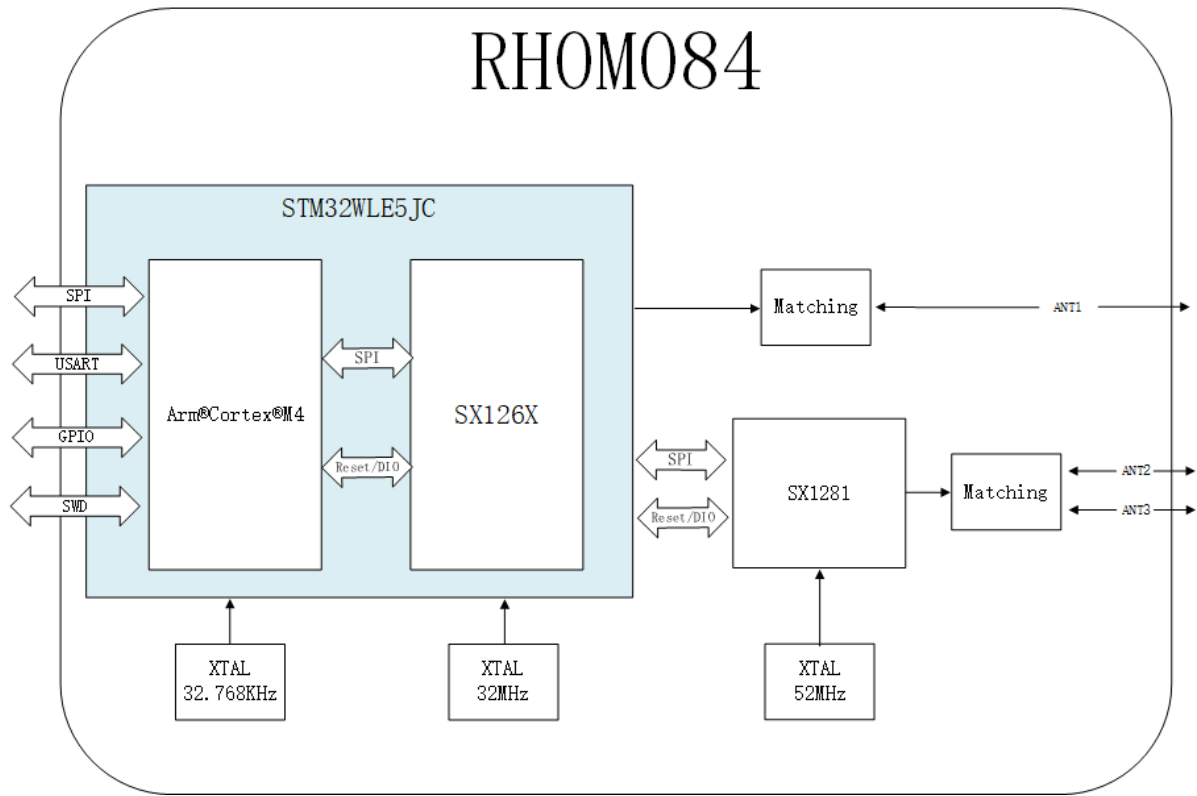
总体描述

RHF0M084内嵌 STM32WLE5JC 和 SX1281, 非常适合于各种物联网节点的设计。

基于多模高性能的 SX126X和SX1281, RHF0M084模块支持(G)FSK 和 LoRa 模式。在 470MHz/868MHz/915MHz LoRa 模式下可以使用 62.5kHz, 125kHz, 250kHz 和 500kHz 带宽。在 2400MHz LoRa 模式下可以使用203.125KHz, 406.25KHz, 812.6KHz, 1625KHz。

基于 STM32WLE5JC MCU, 模块提供 UART和 GPIOs 供用户根据应用选用。 建议使用两线接口 (SWIM) 烧录。

原理框图:



管脚定义

1	VCC	GND	33
2	GND	ANT_1	32
3	PA8	GND	31
4	PA9	ANT_2	30
5	PA10	GND	29
6	NSS	LoRa sub gig RF	28
7	SCK	NRST	27
8	MISO	PC13	26
9	MOSI	SDA	25
10	USART_CTS	SCL	24
11	USART_RTS	USART_RX	23
12	SWDIO	USART_TX	22
13	SWCLK	PB5	21
14	PA15		
15	PB3		
16	PB4		
17	NC		
18	NC		
19	NC		
20	PA3		

Number	Name	Type	Description
1	VCC	-	Supply voltage for the module
2	GND	-	Ground
3	PA8	I/O	MCU GPIO
4	PA9	I/O	MCU GPIO
5	PA10	I/O	MCU GPIO
6	NSS	I/O	NSS of SPI from MCU or GPIO from MCU, PB12
7	SCK	I/O	SCK of SPI from MCU or GPIO from MCU, PB13
8	MISO	I/O	MISO of SPI from MCU or GPIO from MCU, PB14
9	MOSI	I/O	MOSI of SPI from MCU or GPIO from MCU, PB15
10	USART_CTS	I/O	USART1_CTS from MCU or GPIO from MCU, PA11
11	USART_RTS	I/O	USART1_RTS from MCU or GPIO from MCU, PA12
12	SWDIO	I/O	SWDIO of SWIM for program download
13	SWCLK	I/O	SWCLK of SWIM for program download
14	PA15	I/O	MCU GPIO
15	PB3	I/O	MCU GPIO
16	PB4	I/O	MCU GPIO
17	NC	-	-
18	NC	-	-
19	NC	-	-
20	PA3	I/O	MCU GPIO
21	PB5	I/O	MCU GPIO
22	USART_TX	I/O	USART1_TX from MCU or GPIO from MCU, PB6
23	USART_RX	I/O	USART1_RX from MCU or GPIO from MCU, PB7
24	SCL	I/O	SCL of I2C from MCU or GPIO from MCU, PB8
25	SDA	I/O	SDA of I2C from MCU or GPIO from MCU, PB9
26	PC13	I/O	MCU GPIO
27	NRST	I	Reset trigger input for MCU
28	LoRa sub gig RF	-	RF input/output PORT3 (470MHz/868MHz/915MHz)
29	GND	-	Ground
30	ANT_2	-	RF input/output PORT2 (2400MHz)

Number	Name	Type	Description
31	GND	-	Ground
32	ANT_1	-	RF input/output PORT1 (2400MHz)
33	GND	-	Ground

备注：2400MHz天线端口批量出货默认打开ANT_1端口

电气性能

• 极限工作条件

达到或超过下表列出的额定最大值会导致设备损坏。

Item	Description	min	max	unit
VCCmr	供电电压	-0.3	+3.9	V
Tmr	环境温度	-55	+115	°C
Pmr	射频输入信号	-	+10	dBm

• 正常工作条件

Item	Description	min	max	unit
VCCop	供电电压	+1.8	+3.6	V
Top	环境温度	-40	+85	°C
Pop	射频输入信号	-	+10	dBm

• 规格指标

ITEMs	Parameter	Specifications	Unit		
Structure	Size	28(L)X 23(W) X 2.8(H)	mm		
	Package	33 pins, SMT			
Electrical Characteristics	power supply	3.3V type	V		
	Sleep current	2uA (WDT on);	uA		
	Operation current (Transmitter+MCU)	105mA @22dBm in 470MHz type	mA		
		118mA @22dBm in 868MHz type			
		111mA @22dBm in 915MHz type			
		24mA @13dBm in 2400MHz type			
	Operation current (Receiver+MCU)	6.7mA @BW125kHz, 470MHz type	mA		
		6.7mA @BW125kHz, 868MHz type			
		6.7mA @BW125kHz, 915MHz type			
		6.7mA @BW125kHz, 2400MHz type			
Output power	21dBm max @470MHz	dBm			
	20dBm max @868MHz				
	19.5dBm max @915MHz				
	12dBm max @2400MHz				
Sensitivity	@SF12, BW125kHz	dBm			
	Fr(MHz)		min	type	max
	470		-	-133	-134
	868		-	-131	-132
	915		-	-131	-132
Harmonics	<-36dBm below 1GHz	dBm			
	<-30dBm above 1GHz	dBm			
Interface	RFIO	RF port			
	UART	1 group of UART, include 2pins			
	I2C	1 group of I2C, include 2 pins			
	ADC	1 ADC Input, include 1pins,12-bit 1Msps			
	NRST	Manual reset pin input			
	SPI	1 group of SPI, include 4 pins			

• 射频性能

○ RF Power vs Power configuration (470MHz)

Configuration	1	2	3	4	5	6	7	8	9	10	11
Current (mA)	32.9	35.11	36.5	38.84	40.28	42.14	44.41	46.63	49.27	51.86	54.79
Output Power (dBm)	0.263	1.396	2.081	3.327	4.131	5.147	6.243	7.226	8.241	9.159	10.082
Configuration	12	13	14	15	16	17	18	19	20	21	22
Current (mA)	58.16	62.3	66.36	70.49	74.02	76.92	80.07	83.57	87.79	93.01	99.63
Output Power (dBm)	11.04	12.059	12.966	13.833	14.747	15.684	16.748	17.766	18.768	19.78	20.768

○ RF Power vs Power configuration (490MHz)

Configuration	1	2	3	4	5	6	7	8	9	10	11
Current (mA)	36.03	38.55	40.11	42.78	44.52	46.84	49.59	52.3	55.46	58.57	62.08
Output Power (dBm)	0.698	1.833	2.539	3.817	4.638	5.654	6.756	7.709	8.726	9.622	10.526
Configuration	12	13	14	15	16	17	18	19	20	21	22
Current (mA)	66.02	70.86	75.49	79.81	83.42	86.59	90.1	93.83	98.12	103.24	109.78
Output Power (dBm)	11.45	12.446	13.314	14.143	15.042	15.951	16.959	17.922	18.886	19.856	20.788

○ RF Power vs Power configuration (868MHz)

Configuration	1	2	3	4	5	6	7	8	9	10	11
Current (mA)	48.86	52.07	54.06	57.62	59.95	62.82	66.12	69.24	72.68	76	79.54
Output Power (dBm)	-0.466	0.638	1.291	2.505	3.301	4.274	5.358	6.328	7.314	8.198	9.032
Configuration	12	13	14	15	16	17	18	19	20	21	22
Current (mA)	83.62	88.45	93.08	97.76	102.15	104.86	107.77	110.92	114.43	118.35	124.41
Output Power (dBm)	9.917	10.871	11.683	12.464	13.359	14.464	15.755	16.92	17.993	18.965	20.01

○ RF Power vs Power configuration (915MHz)

Configuration	1	2	3	4	5	6	7	8	9	10	11
Current (mA)	48.45	51.52	53.39	56.65	58.76	61.35	64.33	67.09	70.2	73.21	76.4
Output Power (dBm)	-2.304	-1.195	-0.511	0.717	1.533	2.536	3.632	4.602	5.601	6.51	7.369
Configuration	12	13	14	15	16	17	18	19	20	21	22
Current (mA)	80.11	84.54	88.81	93.07	95.91	96.96	98.07	99.69	102.06	105.51	111.03
Output Power (dBm)	8.292	9.258	10.106	10.94	12.049	13.261	14.629	15.893	17.078	18.205	19.452

o **RF Power vs Power configuration (2400MHz)**

Configuration	-2	-1	0	1	2	3	4	5
Current (mA)				10.83	11.36	12.03	12.68	13.5
Output Power (dBm)				0.92	1.868	2.893	3.811	4.837
Configuration	6	7	8	9	10	11	12	13
Current (mA)	14.35	15.28	16.37	17.44	18.57	19.77	21.12	22.93
Output Power (dBm)	5.777	6.709	7.669	8.529	9.375	10.184	11.048	11.801

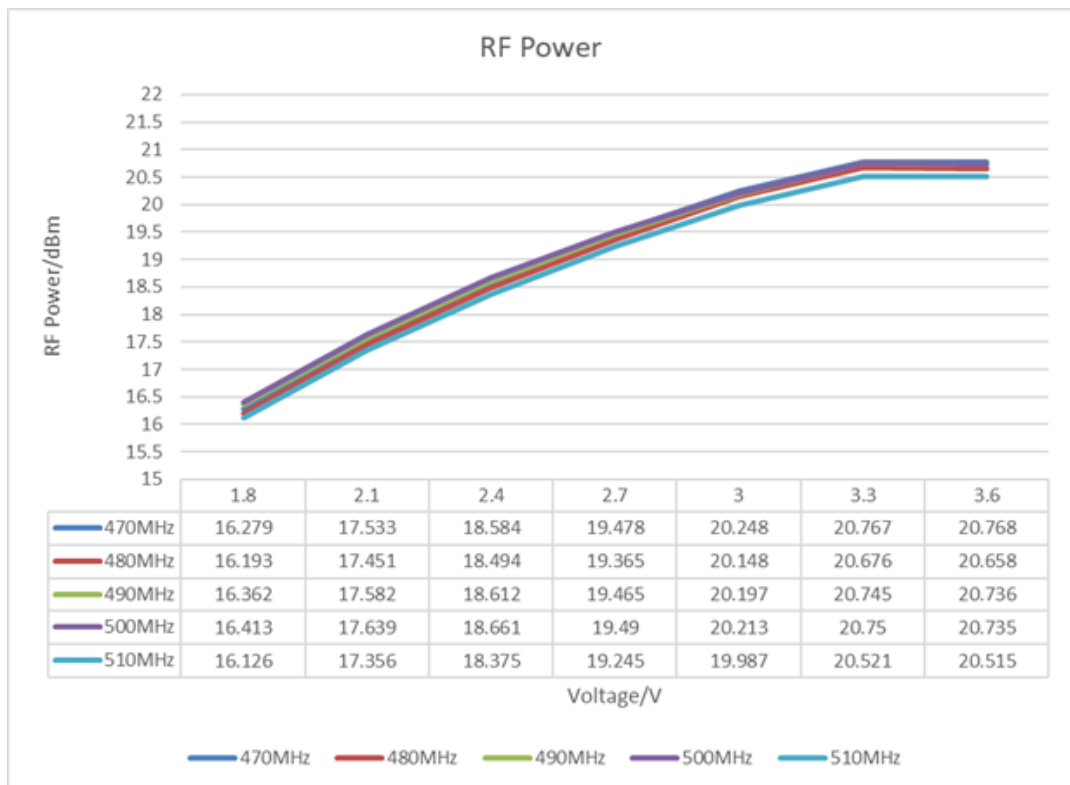
o **RF Power vs Power configuration (2460MHz)**

Configuration	-2	-1	0	1	2	3	4	5
Current (mA)				10.66	11.14	11.75	12.35	13.1
Output Power (dBm)				0.657	1.613	2.643	3.538	4.582
Configuration	6	7	8	9	10	11	12	13
Current (mA)	13.88	14.73	15.72	16.68	17.71	18.8	20.04	21.91
Output Power (dBm)	5.515	6.428	7.422	8.283	9.135	9.991	10.847	11.638

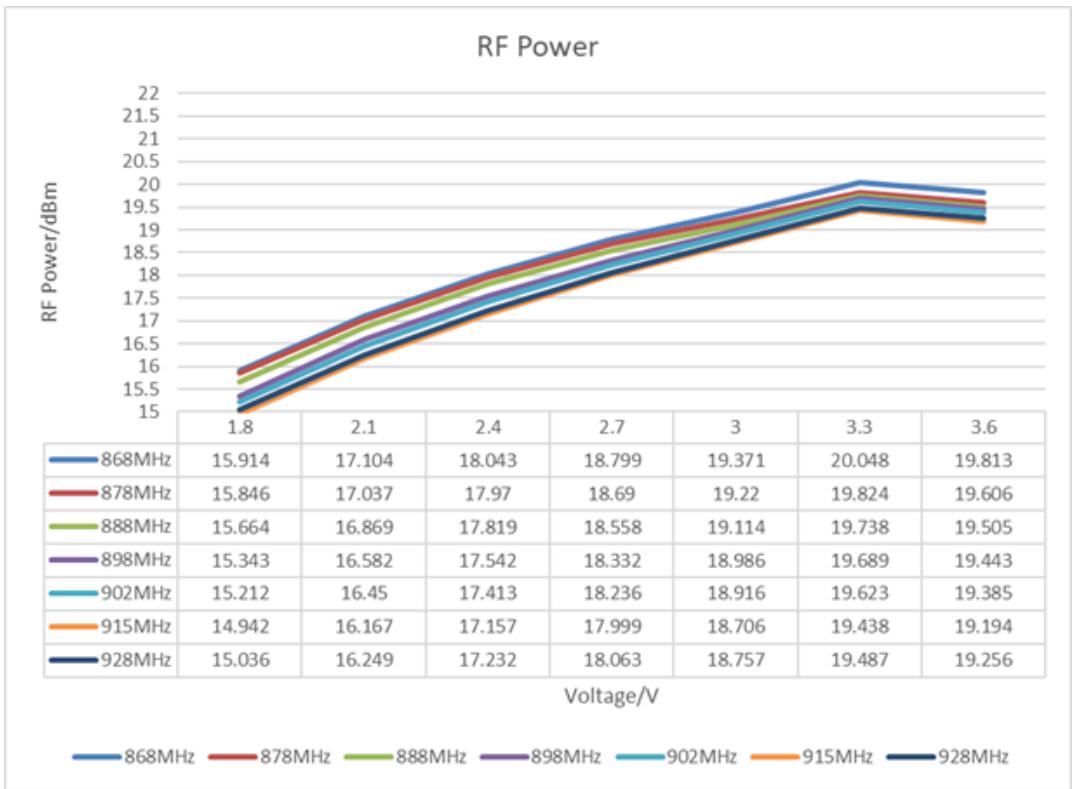
o **RF Power vs Power configuration (2500MHz)**

Configuration	-2	-1	0	1	2	3	4	5
Current (mA)				10.96	11.48	12.13	12.76	13.56
Output Power (dBm)				0.946	1.896	2.925	3.85	4.876
Configuration	6	7	8	9	10	11	12	13
Current (mA)	14.4	15.3	16.35	17.38	18.44	19.6	20.92	22.83
Output Power (dBm)	5.828	6.748	7.754	8.606	9.487	10.332	11.195	11.973

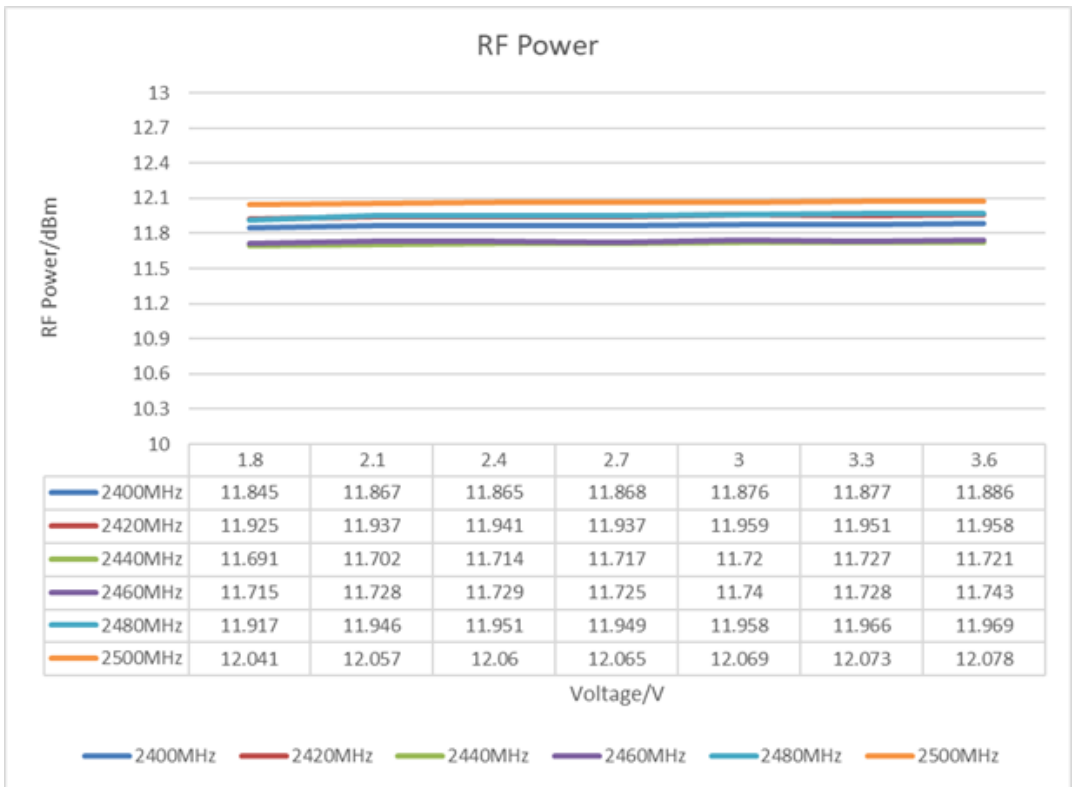
o **RF Power vs Voltage (470~510MHz)**



o **RF Power vs Voltage (868~915MHz)**



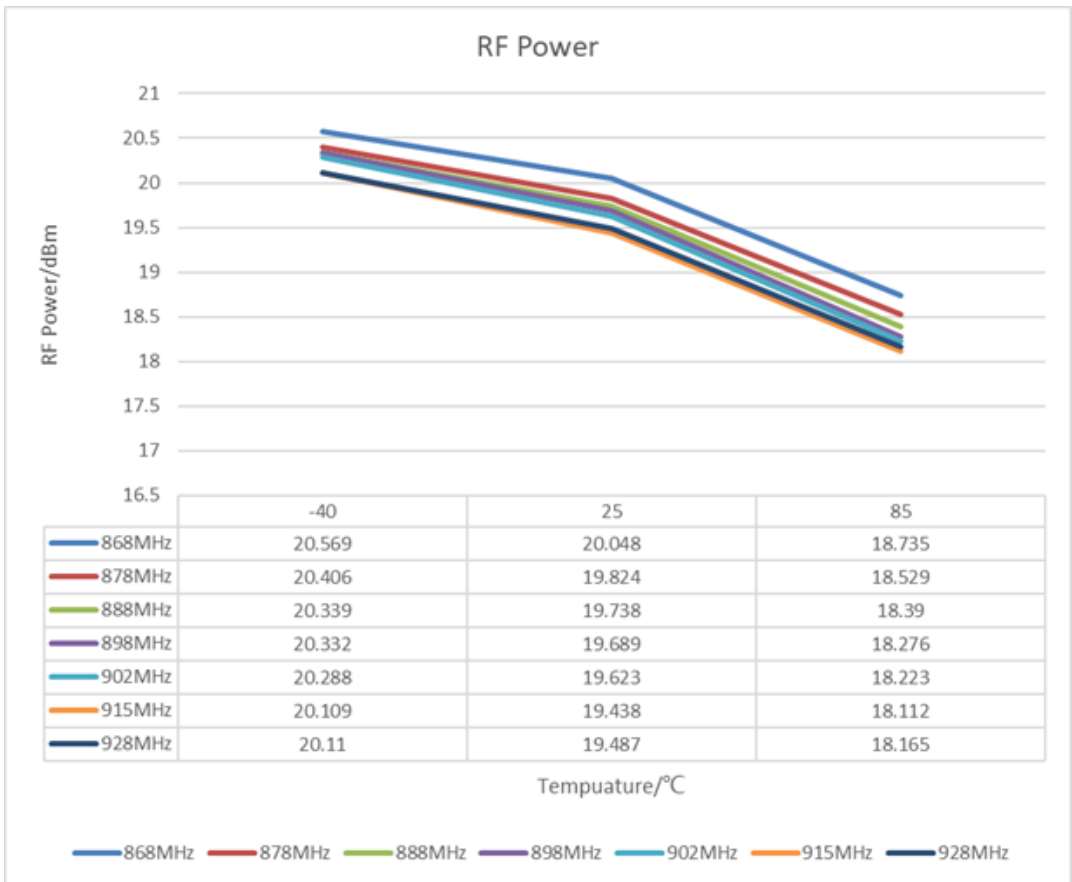
○ RF Power vs Voltage (2400~2500MHz)



○ RF Power VS Temperature (470~510MHz)



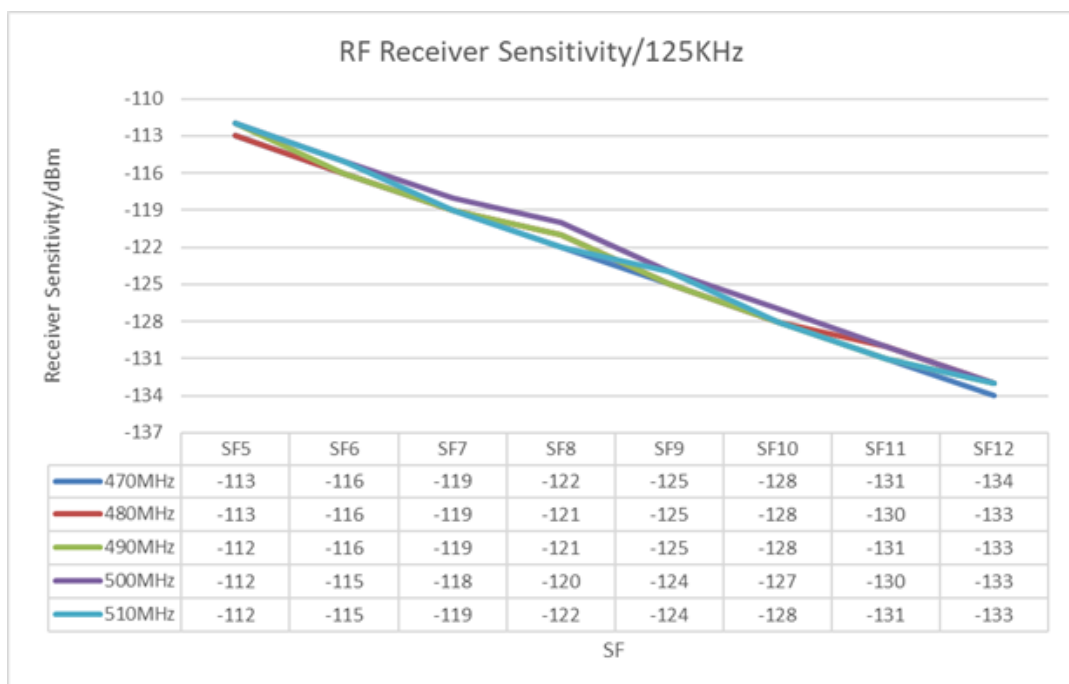
○ RF Power VS Temperature (868~915MHz)



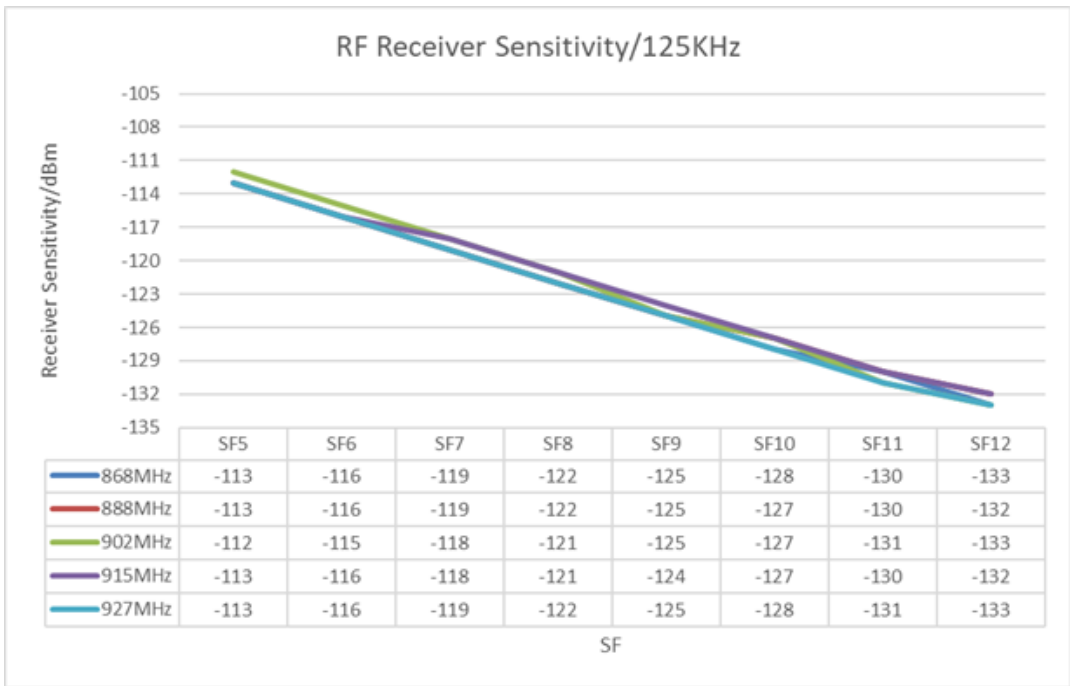
○ RF Power VS Temperature (2400~2500MHz)



○ RF Receiver Sensitivity vs Spreading factor (470~510MHz)



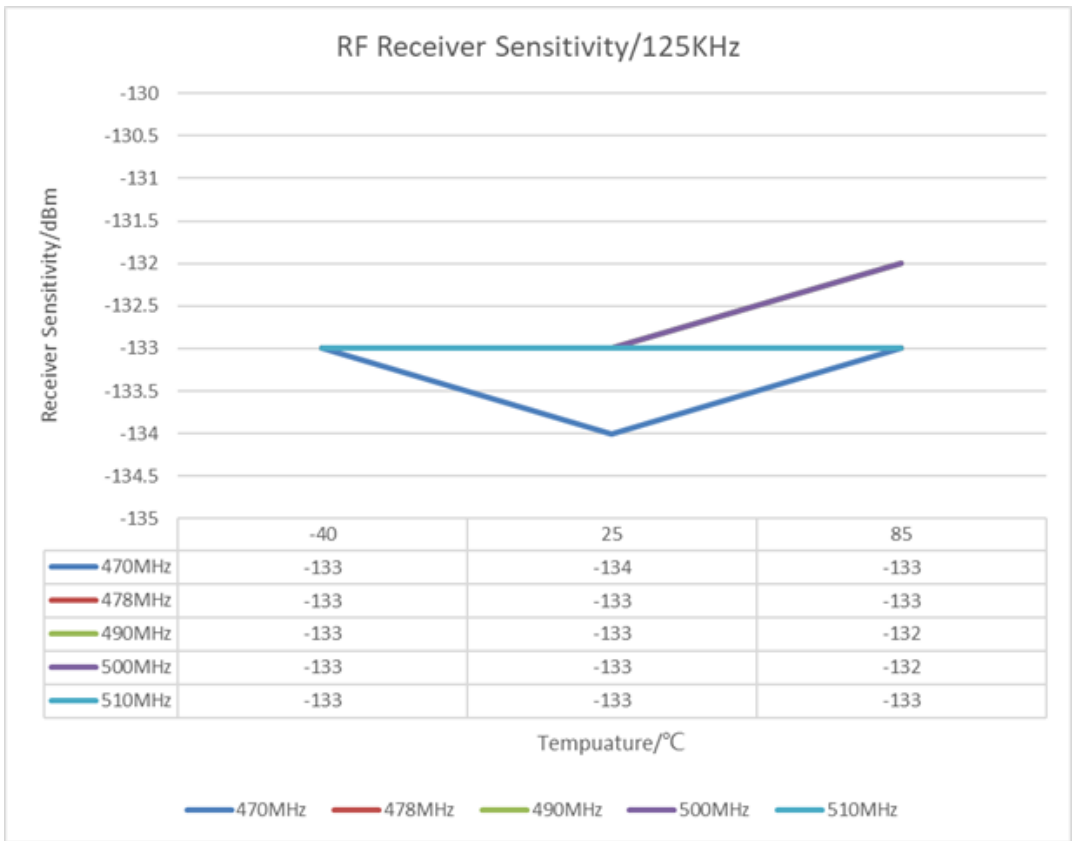
○ RF Receiver Sensitivity vs Spreading factor (868~915MHz)



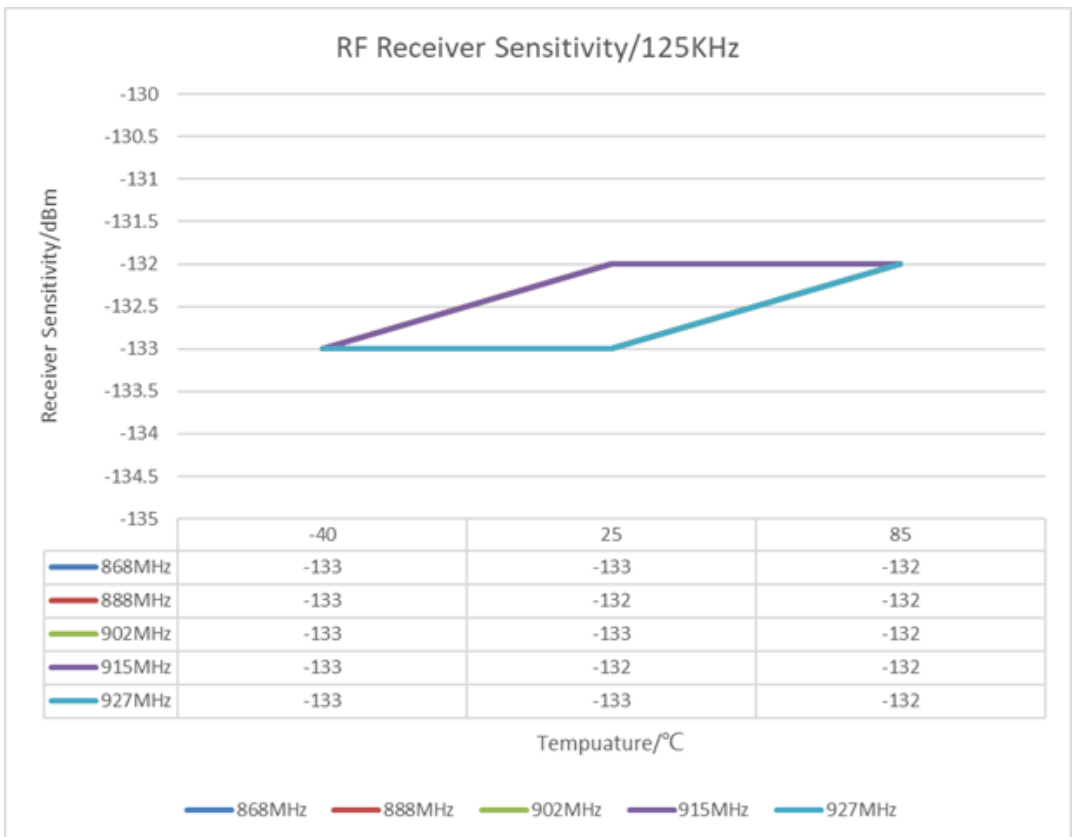
- RF Receiver Sensitivity vs Spreading factor (2400~2500MHz)



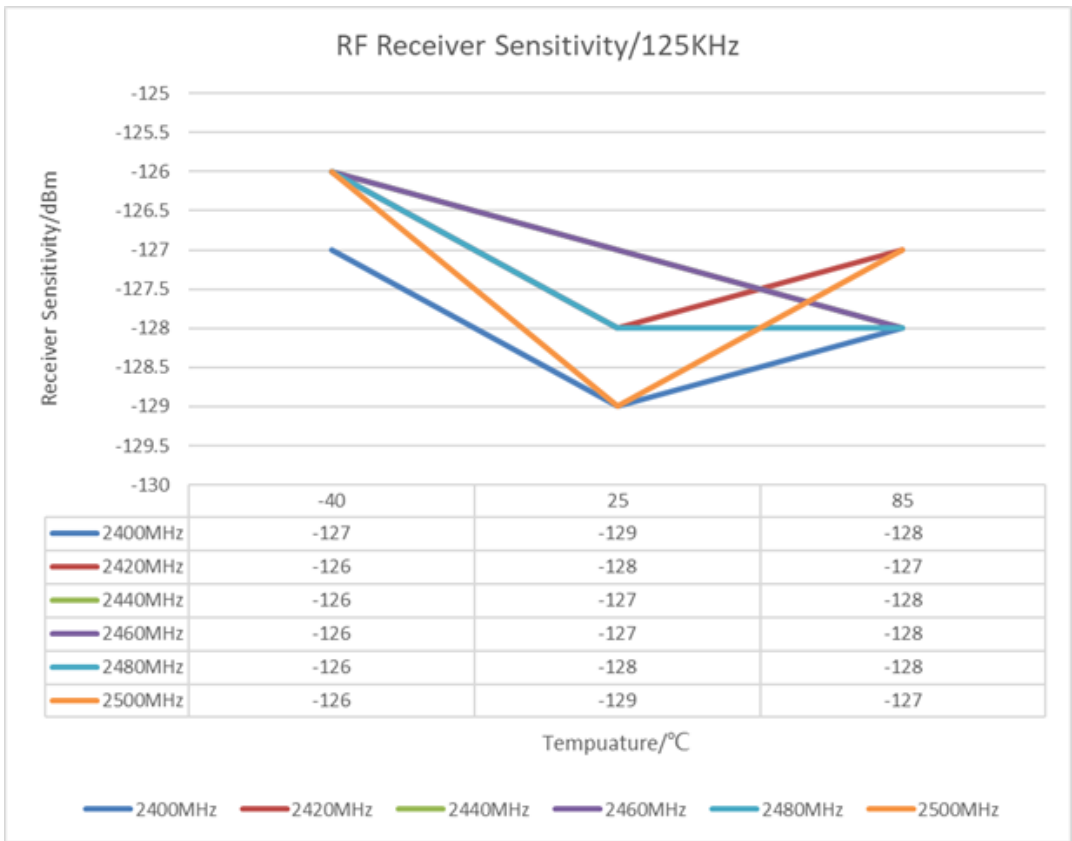
- RF Receiver Sensitivity/SF12 VS Temperature (470~510MHz)



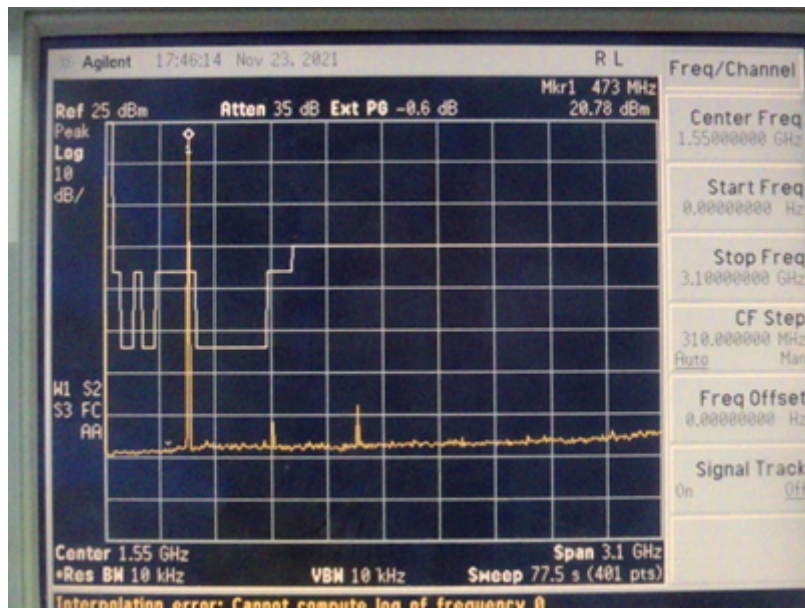
○ RF Receiver Sensitivity/SF12 VS Temperature (868~915MHz)



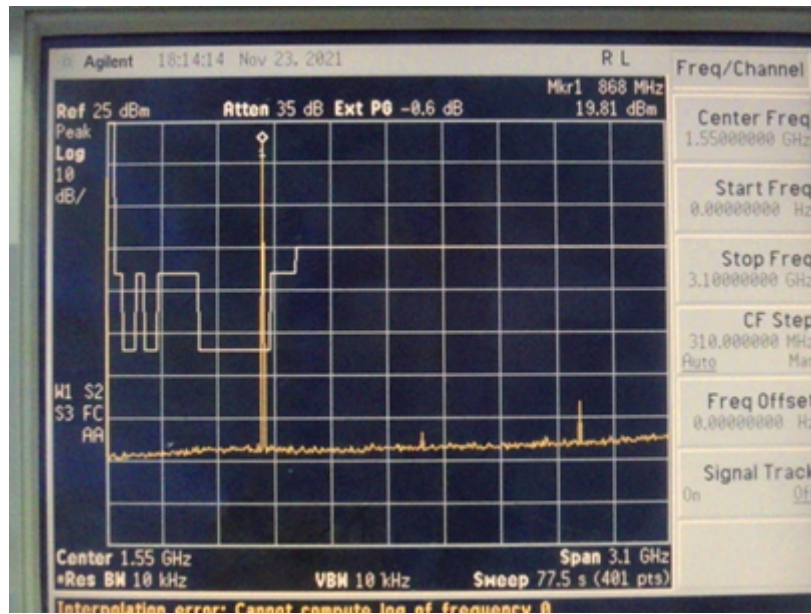
○ RF Receiver Sensitivity/SF12 VS Temperature (2400~2500MHz)



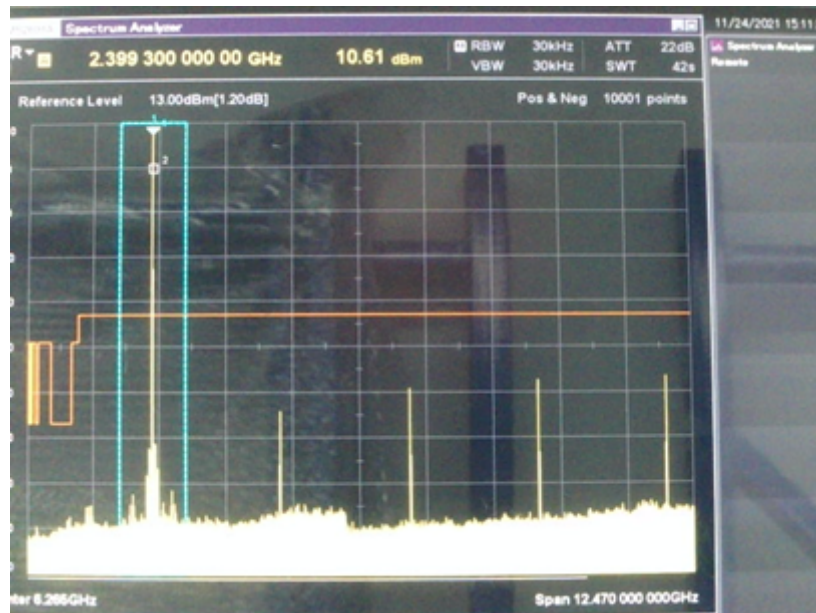
- Harmonic(25MHz~3GHz)@Frf=470MHz, TXOP=22dBm



- Harmonic(25MHz~3GHz)@Frf=868MHz, TXOP=22dBm



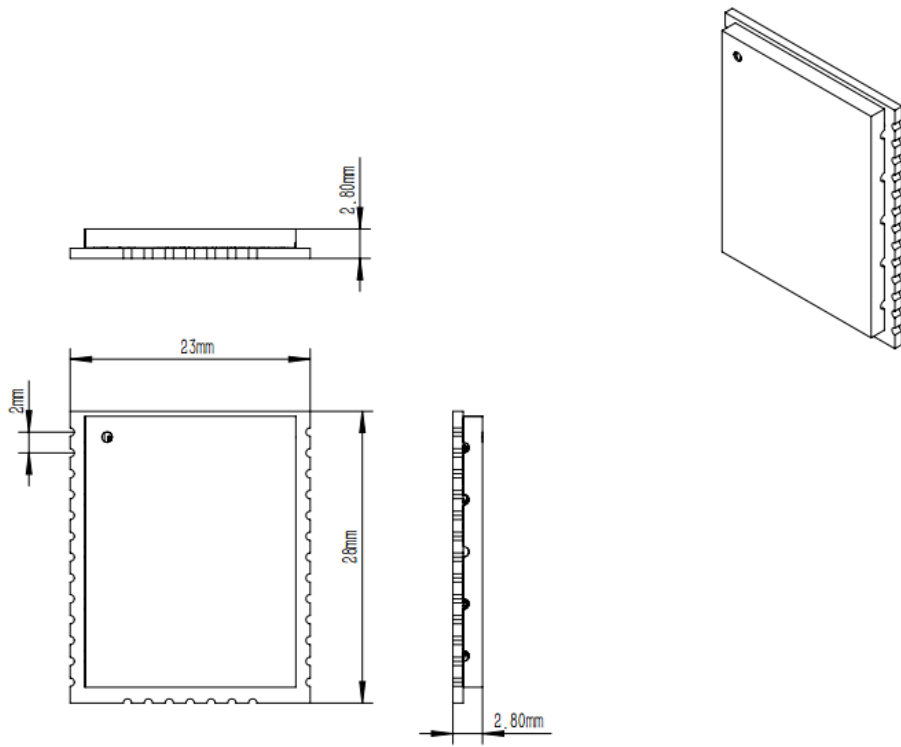
- Harmonic(25MHz~3GHz)@Frq=2400MHz, TXOP=22dBm



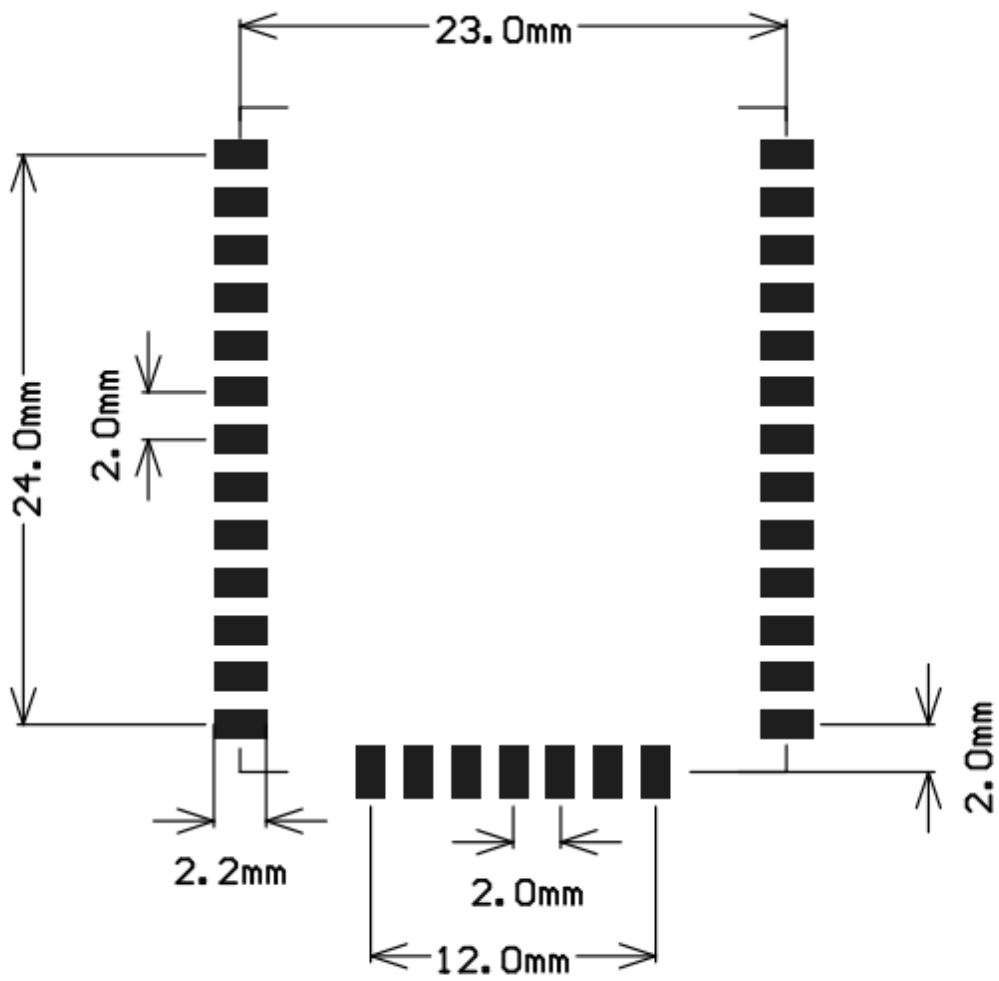
应用信息

1. 封装信息

RHF0M084具有33pin的贴片封装:



下图给出了建议的Layout封装尺寸图：

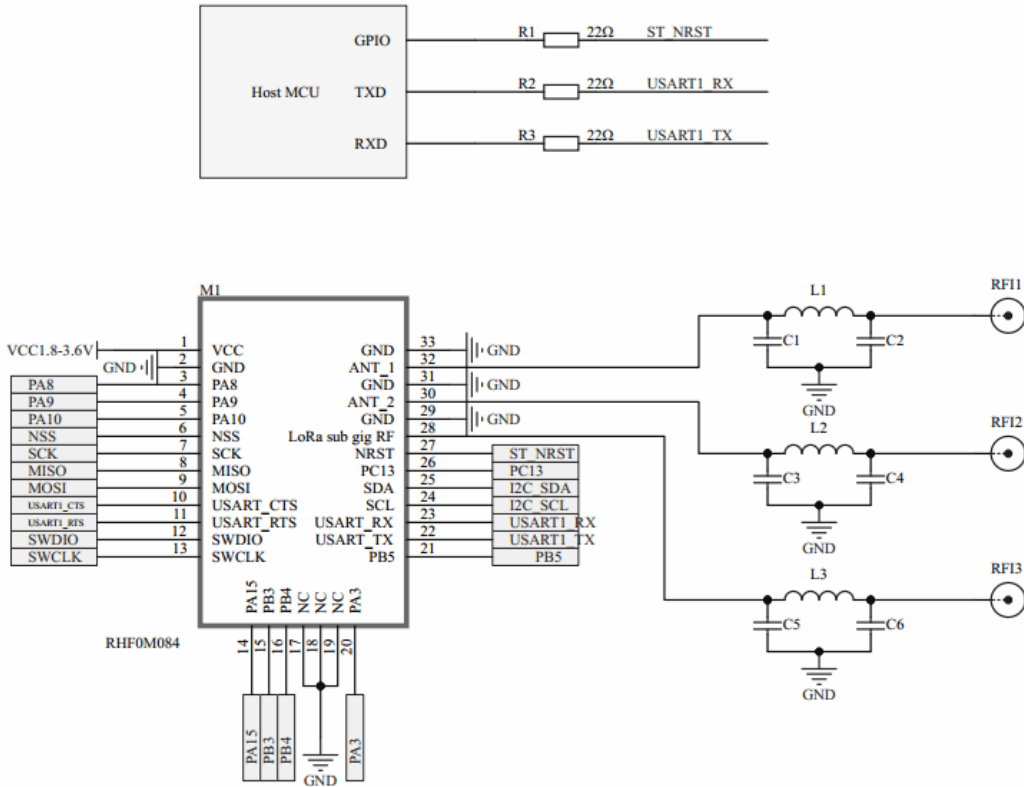


模块对外接口

除了几个必要的GPIO口和一组SPI口被用于内部射频收发机的控制外，MCU的其他GPIO都已引出，包括UART(用于AT指令)等。对于那些希望在模块的片上MCU进行软件开发或拓展外设的用户来说，这些丰富的GPIO接口能满足绝大多数应用的需求。

基于RHF0M084模块的参考设计

RHF0M084内嵌全球的LoRaWAN®协议和AT指令集。这将使得基于该模块的LoRaWAN®节点设计变得非常容易，以下是使用RHF0M084快速启动LoRaWAN®应用程序的典型参考设计。只需将UART和NRST连接到主机MCU并发送AT命令即可。



LoRaWAN®应用信息

• LoRaWAN®应用

LoRaWAN®网络的拓扑结构是星形网络，网关作为节点和网络服务器之间的中继。网关通过标准的IP链路连接到网络服务器，而节点设备使用LoRa®或者FSK与一个或者多个网关通信。通信是双向的，尽管主要是从节点到网络服务器的上行通信。

节点和网关之间的通信使用不同的频率和速率，速率的选择是功耗和距离的折中，不同的速率之间互不干扰。根据不同的扩频因子和带宽，LoRa®的速率可以从300bps到50Kbps。为了使电池寿命和网络容量最大化，网络服务器通过速率自适应(ADR)管理节点的速率和输出功率。

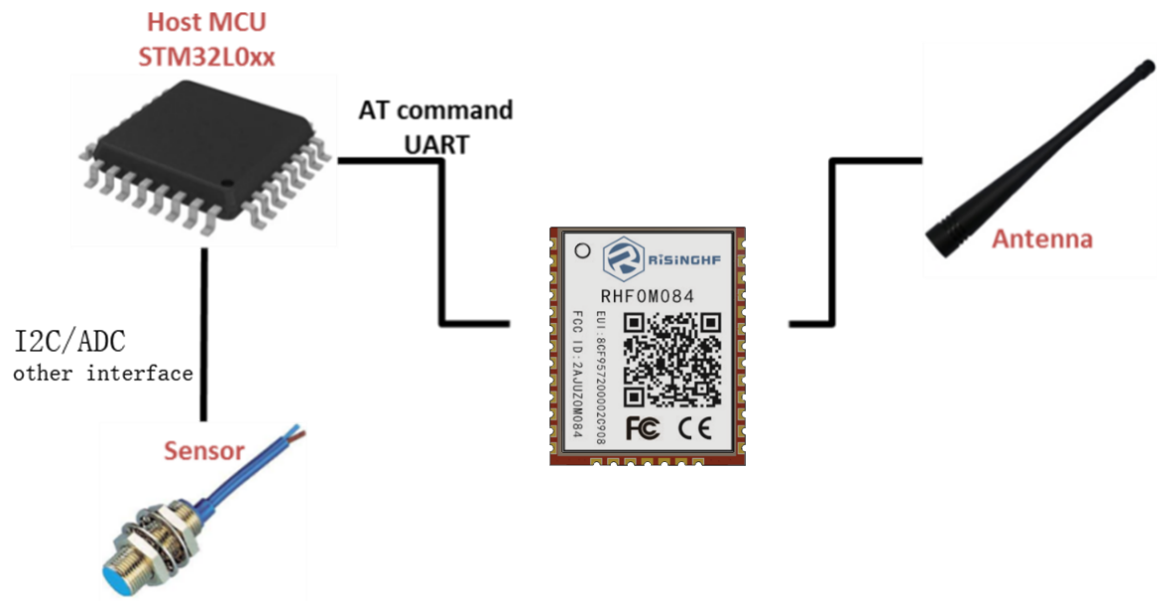
节点设备可能在任何时间，以任何速率，在随机的一个信道上发射，只要符合以下条件：

1. 节点当前使用的信道是伪随机的。这使得系统抗干扰的能力更强
2. 节点每次的最大传输时间(信道的驻留时间)和占空比取决于所用的频段和当地的规范

RHF0M084模块在睡眠模式下电流仅2uA, 该模块非常适合于LoRaWAN®的各种应用。 .

• 基于RHF0M084设计LoRaWAN®无线传感器

RHF0M084是封装了全球LoRaWAN®标准协议的AT指令集。客户只需要一颗很简单的MCU作为主控，便可通过串口来控制RHF0M084，从而轻松实现LoRaWAN®协议。这有助于帮助客户快速地将传感器产品推向LoRaWAN®市场。



订购信息

Part Number	MCU	TX Power (dBm)	AT Modem
RHF0M084	ROM 256KB / RAM 60KB	22@LF (470MHz)/22dBm@(868/915MHz)/13dBm@2400MHz	Yes

联系 salescn@risinghf.com 获取更多订购信息。